

RoHS Compliant Product

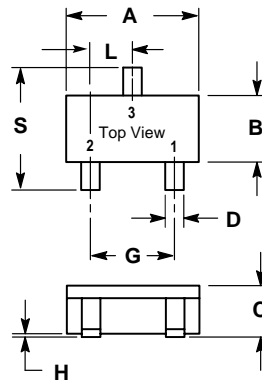
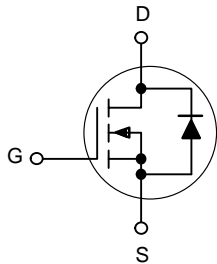
## Description

The SMG2314 utilized advanced processing techniques to achieve the lowest possible on-resistance, extremely efficient and cost-effectiveness device. The SMG2314 is universally used for all commercial-industrial applications.

## Features

- \* Low On-Resistance
- \* Capable Of 2.5V Gate Drive

Marking : 2314



| SC-59               |      |      |
|---------------------|------|------|
| Dim                 | Min  | Max  |
| A                   | 2.70 | 3.10 |
| B                   | 1.40 | 1.60 |
| C                   | 1.00 | 1.30 |
| D                   | 0.35 | 0.50 |
| G                   | 1.70 | 2.10 |
| H                   | 0.00 | 0.10 |
| J                   | 0.10 | 0.26 |
| K                   | 0.20 | 0.60 |
| L                   | 0.85 | 1.15 |
| S                   | 2.40 | 2.80 |
| All Dimension in mm |      |      |

## Absolute Maximum Ratings

| Parameter                                                    | Symbol                               | Ratings  | Unit |
|--------------------------------------------------------------|--------------------------------------|----------|------|
| Drain-Source Voltage                                         | V <sub>DS</sub>                      | 20       | V    |
| Gate-Source Voltage                                          | V <sub>GS</sub>                      | ±12      | V    |
| Continuous Drain Current, <sup>3</sup> V <sub>GS</sub> @4.5V | I <sub>D</sub> @T <sub>A</sub> =25°C | 3.5      | A    |
| Continuous Drain Current, <sup>3</sup> V <sub>GS</sub> @4.5V | I <sub>D</sub> @T <sub>A</sub> =70°C | 2.8      | A    |
| Pulsed Drain Current <sup>1,2</sup>                          | I <sub>DM</sub>                      | 10       | A    |
| Total Power Dissipation                                      | P <sub>D</sub> @T <sub>A</sub> =25°C | 1.38     | W    |
| Linear Derating Factor                                       |                                      | 0.01     | W/°C |
| Operating Junction and Storage Temperature Range             | T <sub>j</sub> , T <sub>stg</sub>    | -55~+150 | °C   |

## Thermal Data

| Parameter                                        | Symbol             | Ratings | Unit |
|--------------------------------------------------|--------------------|---------|------|
| Thermal Resistance Junction-ambient <sup>3</sup> | R <sub>thj-a</sub> | 90      | °C/W |

### Electrical Characteristics( T<sub>j</sub>=25°C Unless otherwise specified)

| Parameter                                           | Symbol                              | Min. | Typ. | Max. | Unit | Test Condition                                                                                                   |
|-----------------------------------------------------|-------------------------------------|------|------|------|------|------------------------------------------------------------------------------------------------------------------|
| Drain-Source Breakdown Voltage                      | BV <sub>DSS</sub>                   | 20   | -    | -    | V    | V <sub>GS</sub> =0V, I <sub>D</sub> =250uA                                                                       |
| Breakdown Voltage Temp. Coefficient                 | ΔBV <sub>DSS</sub> /ΔT <sub>j</sub> | -    | 0.02 | -    | V/°C | Reference to 25°C, I <sub>D</sub> =1mA                                                                           |
| Gate Threshold Voltage                              | V <sub>GS(th)</sub>                 | 0.5  | -    | 1.2  | V    | V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250uA                                                         |
| Gate-Source Leakage Current                         | I <sub>GSS</sub>                    | -    | -    | ±100 | nA   | V <sub>GS</sub> =±12V                                                                                            |
| Drain-Source Leakage Current (T <sub>j</sub> =25°C) | I <sub>DSS</sub>                    | -    | -    | 1    | uA   | V <sub>DS</sub> =20V, V <sub>GS</sub> =0                                                                         |
| Drain-Source Leakage Current (T <sub>j</sub> =70°C) |                                     | -    | -    | 10   | uA   | V <sub>DS</sub> =16V, V <sub>GS</sub> =0                                                                         |
| Static Drain-Source On-Resistance                   | R <sub>DS(ON)</sub>                 | -    | -    | 75   | mΩ   | V <sub>GS</sub> =4.5V, I <sub>D</sub> =3.5A                                                                      |
|                                                     |                                     | -    | -    | 125  |      | V <sub>GS</sub> =2.5V, I <sub>D</sub> =1.2A                                                                      |
| Total Gate Charge <sup>2</sup>                      | Q <sub>g</sub>                      | -    | 4    | 7    | nC   | I <sub>D</sub> =3A<br>V <sub>DS</sub> =16V<br>V <sub>GS</sub> =4.5V                                              |
| Gate-Source Charge                                  | Q <sub>gs</sub>                     | -    | 0.7  | -    |      |                                                                                                                  |
| Gate-Drain ("Miller") Charge                        | Q <sub>gd</sub>                     | -    | 2    | -    |      |                                                                                                                  |
| Turn-on Delay Time <sup>2</sup>                     | T <sub>d(ON)</sub>                  | -    | 6    | -    | nS   | V <sub>DD</sub> =15V<br>I <sub>D</sub> =1A<br>V <sub>GS</sub> =5V<br>R <sub>G</sub> =3.3Ω<br>R <sub>D</sub> =15Ω |
| Rise Time                                           | T <sub>r</sub>                      | -    | 8    | -    |      |                                                                                                                  |
| Turn-off Delay Time                                 | T <sub>d(OFF)</sub>                 | -    | 10   | -    |      |                                                                                                                  |
| Fall Time                                           | T <sub>f</sub>                      | -    | 3    | -    |      |                                                                                                                  |
| Input Capacitance                                   | C <sub>iss</sub>                    | -    | 230  | 370  | pF   | V <sub>GS</sub> =0V<br>V <sub>DS</sub> =20V<br>f=1.0MHz                                                          |
| Output Capacitance                                  | C <sub>oss</sub>                    | -    | 55   | -    |      |                                                                                                                  |
| Reverse Transfer Capacitance                        | C <sub>rss</sub>                    | -    | 40   | -    |      |                                                                                                                  |
| Forward Transconductance                            | G <sub>fs</sub>                     | -    | 7    | -    | S    | V <sub>DS</sub> =5V, I <sub>D</sub> =3A                                                                          |
| Gate Resistance                                     | R <sub>g</sub>                      | -    | 1.1  | 1.7  | Ω    | f=1.0MHz                                                                                                         |

### Source-Drain Diode

| Parameter                       | Symbol          | Min. | Typ. | Max. | Unit | Test Condition                                           |
|---------------------------------|-----------------|------|------|------|------|----------------------------------------------------------|
| Forward On Voltage <sup>2</sup> | V <sub>DS</sub> | -    | -    | 1.2  | V    | I <sub>S</sub> =1.2A, V <sub>GS</sub> =0V.               |
| Reverse Recovery Time           | T <sub>rr</sub> | -    | 16   | -    | nS   | I <sub>S</sub> =3A, V <sub>GS</sub> =0V<br>di/dt=100A/us |
| Reverse Recovery Charge         | Q <sub>rr</sub> | -    | 8    | -    | nC   |                                                          |

Notes: 1.Pulse width limited by Max. junction temperature.

2.Pulse width ≤300us, dutycycle ≤2%.

3.Surface mounted on FR4 board, t ≤10sec.

### Characteristics Curve

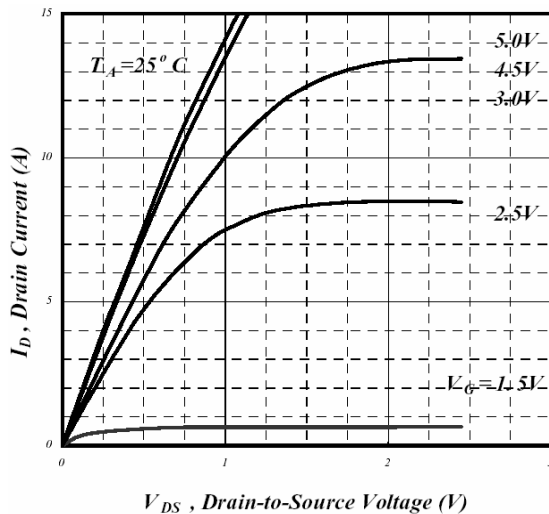


Fig 1. Typical Output Characteristics

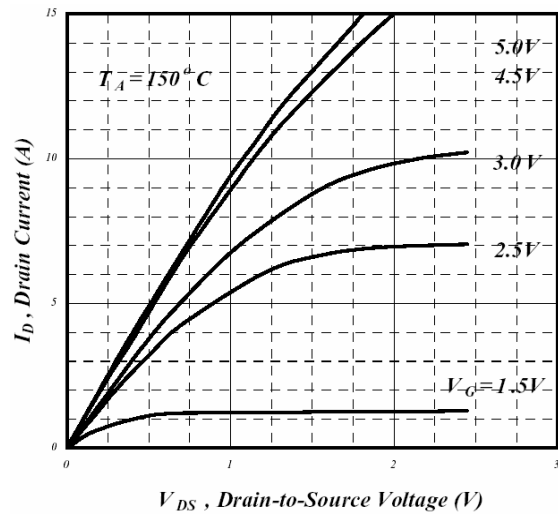


Fig 2. Typical Output Characteristics

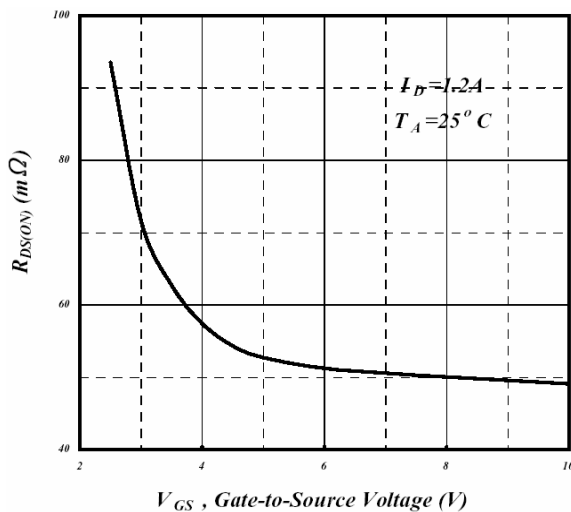


Fig 3. On-Resistance v.s. Gate Voltage

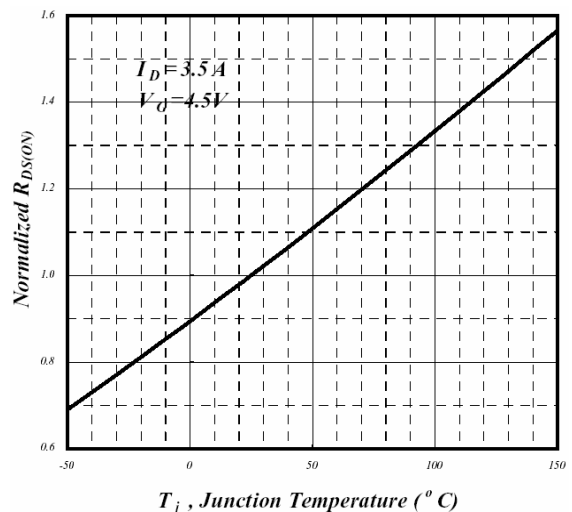


Fig 4. Normalized On-Resistance v.s. Junction Temperature

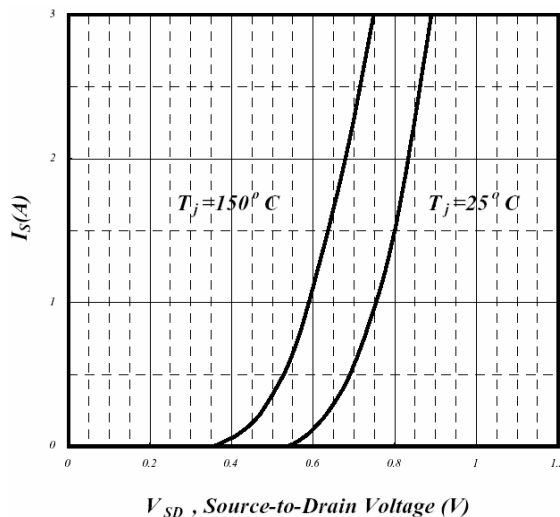


Fig 5. Forward Characteristics of Reverse Diode

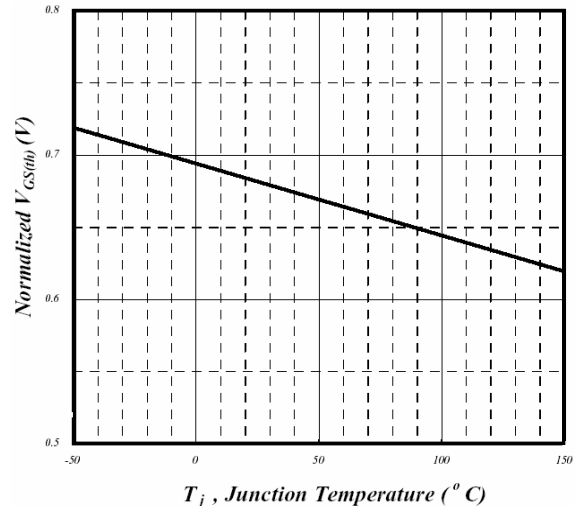
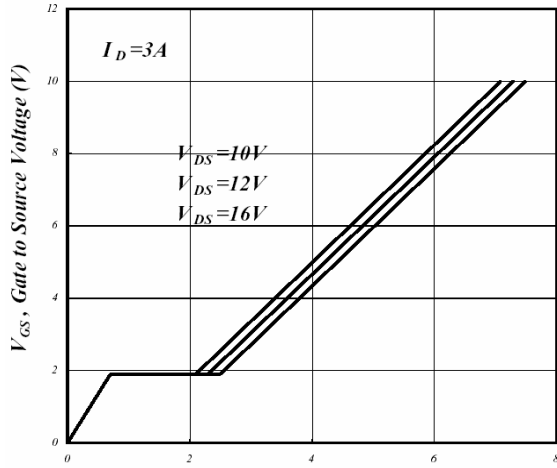
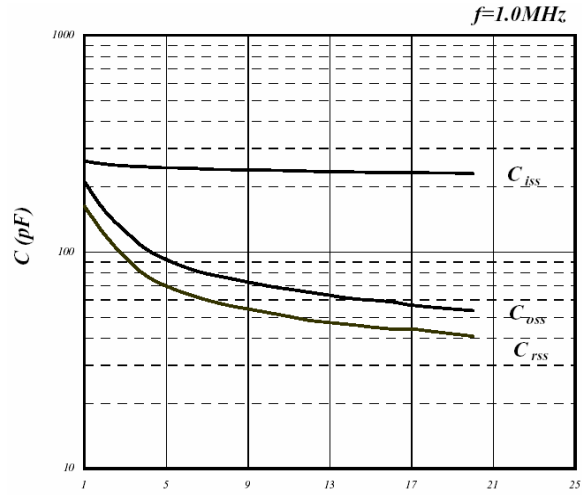


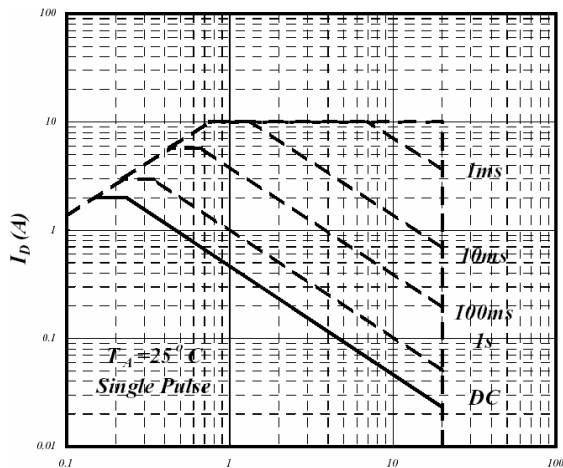
Fig 6. Gate Threshold Voltage v.s. Junction Temperature



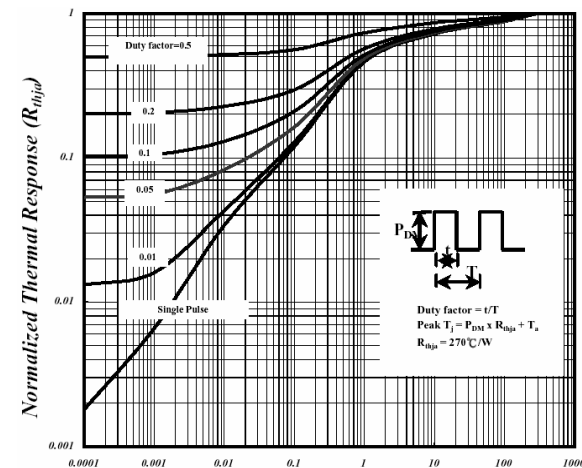
**Fig 7. Gate Charge Characteristics**



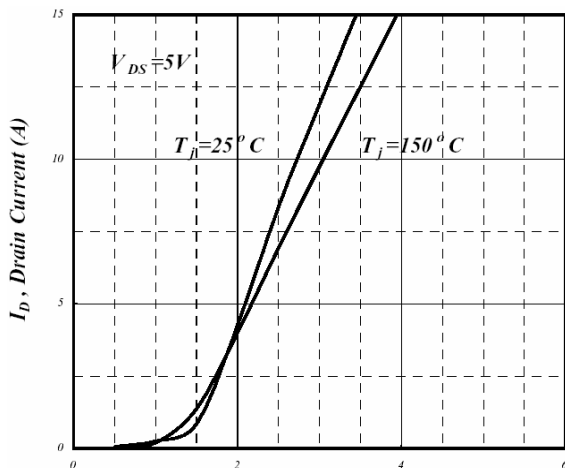
**Fig 8. Typical Capacitance Characteristics**



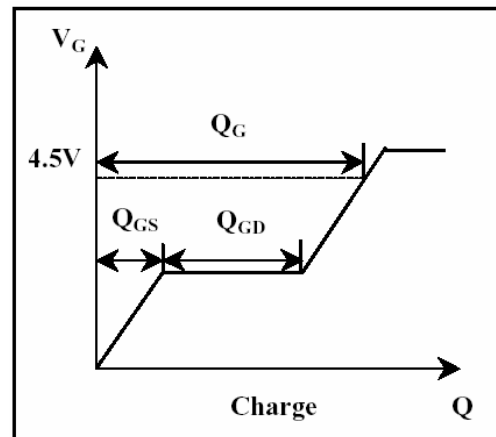
**Fig 9. Maximum Safe Operating Area**



**Fig 10. Effective Transient Thermal Impedance**



**Fig 11. Transfer Characteristics**



**Fig 12. Gate Charge Waveform**